

Sensitive Gate Triacs Sillicon Bidirectional Thyristors

TRIACS 8 AMPERES RMS 600 VOLTS

TO-220AB

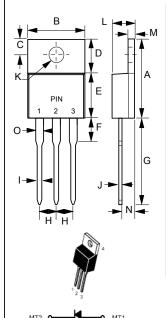
FEATURES

- Sensitive Gate Allows Triggering by Microcontrollers and other Logic Circuits
- Uniform Gate Trigger Currents in Three Quadrants; Q1, Q2, and Q3
- High Commutating di/dt 8.0 A/ms Minimum at 110°C
- Maximum Values of IGT, VGT and IH Specified for Ease of Design
- On-State Current Rating of 8 Amperes RMS at 70°C
- High Surge Current Capability 70 Amperes
- Blocking Voltage to 800 Volts
- Rugged, Economical TO220AB Package
- Pb-Free Package

MECHANICAL DATA

• Case: Molded plastic

• Weight: 0.07 ounces, 2.0 grams



TO-220AB					
DIM.	MIN.	MAX.			
Α	14.22	15.88			
В	9.65	10.67			
С	2.54	3.43			
D	5.84	6.86			
E	8.26	9.28			
F	-	6.35			
G	12.70	14.73			
Н	2.29	2.79			
I	0.51	1.14			
J	0.40	0.67			
K	3.53 Ø	4.09 Ø			
L	3.56	4.83			
М	1.14	1.40			
N	2.03	2.92			
0	1.17	1.37			
All Dime	nsions in r	nillimeter			

	PIN ASSIGNMENT
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

MAXIMUM RATINGS (Tj= 25℃ unless otherwise noticed)

Rating		Value	Unit
Peak Repetitive Off– State Voltage (1) (TJ= -40 to 110℃, Sine Wave, 50 to 60 Hz; Gate Open)	Vdrm, Vrrm	600	Volts
On-State RMS Current (Full Cycle Sine Wave 50 to 60 Hz, Tc =70℃)	IT(RMS)	8.0	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, TJ= 25℃)	Ітѕм	70	Amps
Circuit Fusing Consideration (t = 8.3 ms)	l ² t	20	A ² s
Peak Gate Power (Tc = 70°C, Tp≦1.0 us)	Рсм	16	Watt
Average Gate Power (Tc = 70°C, t = 8.3 ms)	PG(AV)	0.35	Watt
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	Tstg	-40 to +150	°C
Notice: (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking	REV	. 7, Dec-2010, K	TXC08

Notice: (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



THERM	$\Lambda I \subset \coprod A$	ADACT	EDICT	100
IDERIVI	AL CD	ARAGI	ERIST	10.5

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case - Junction to Ambient	RthJC RthJA	2.2 62.5	°C/ W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	$^{\circ}$ C

ELECTRICAL CHARACTERISTICS (TJ=25°C unless otherwise noted; Electrical apply in both directions)

Characteristics	Symbol	Min	Тур	Max	Unit
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OFF CHARACTERISTICS

Peak Reptitive Forward or Reverse Blocking Current (VD=Rated VDRM, VRRM; Gate Open)	TJ=25℃ TJ=110℃	IDRM IRRM	 	10 2.0	uA mA

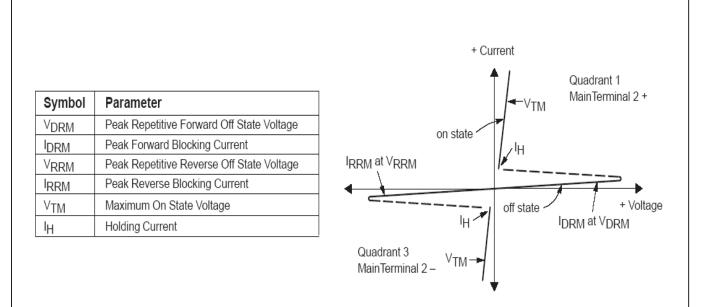
ON CHARACTERISTICS

Peak On-State Voltage (ITM= \pm 11A Peak @Tp \leq 2.0 ms, Duty Cycle \leq 2%)	Vтм			1.85	Volts
Gate Trigger Current (V _D = 12V; R _L = 100 Ohms)	IGT1 IGT2 IGT3		2.0 3.0 3.0	5.0 5.0 5.0	mA
Gate Trigger Voltage (V _D = 12 V; R _L =100 Ohms)	VGT1 VGT2 VGT3	0.45 0.45 0.45	0.62 0.60 0.65	1.5 1.5 1.5	Volts
Latching Current (V _D = 24 V, IG = 5 mA)	L1 L2 L3		5.0 10 5.0	15 20 15	mA
Holding Current (VD = 12 V, Initiating Current = ± 150 mA, Gate Open)	Тн		3.0	10	mA

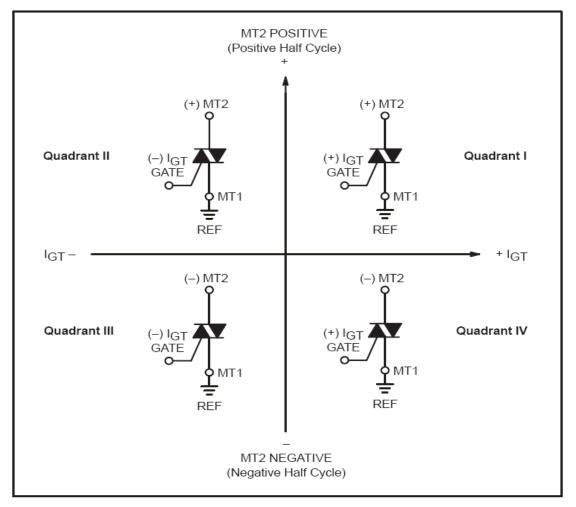
DYNAMIC CHARACTERISTICS

Critical Rate of Rise of Off-State Voltage (VD = Rated VDRM, Exponential Waveform, RGK=510 Ohms, TJ=110°C)	dv/dt	25	75	 V/us
Rate of Change of Commutating Current (VD = 400 V, ITM = 3.5A, Commutating dv/dt = 10 V/us, Gate Open, T_J = 110 $^{\circ}$ C, f = 500 Hz, Cs = 0.01 uF, Rs = 15 Ohms)	di/dt(c)	8.0	10	 A/ms



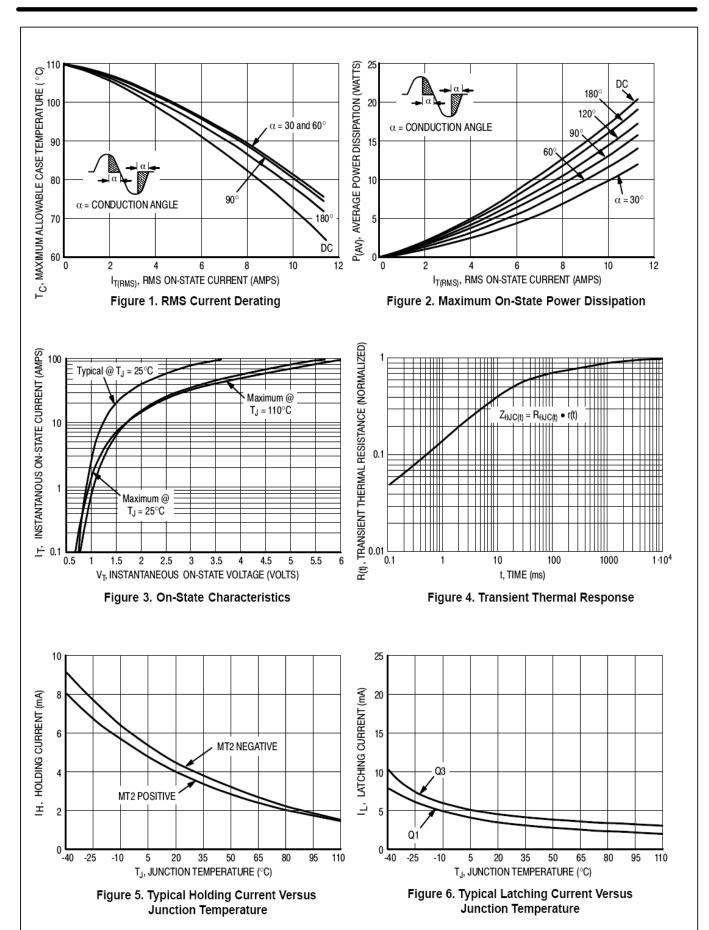


Quadrant Definitions

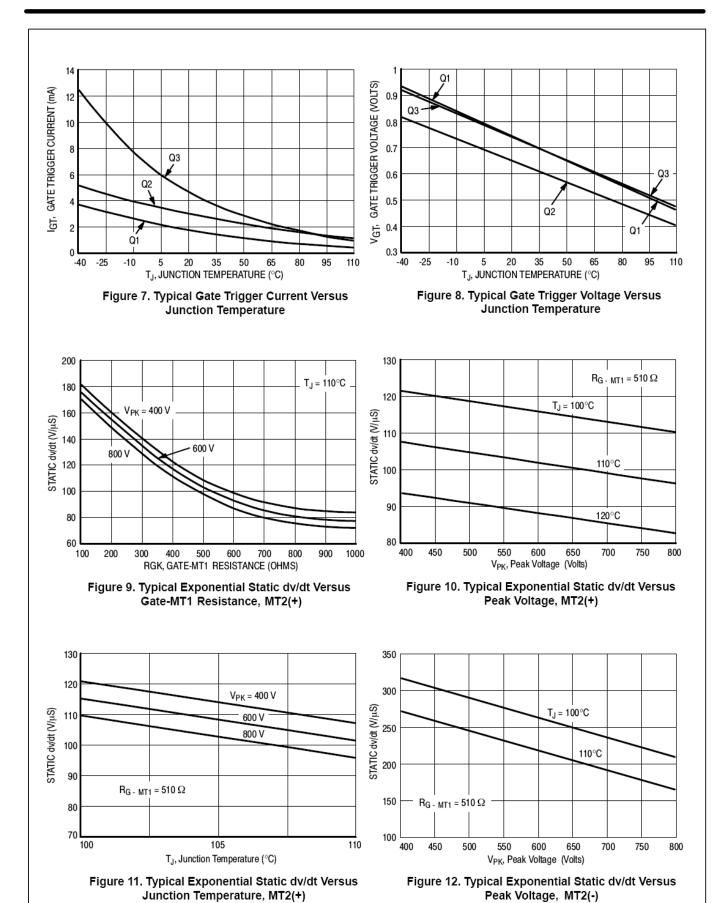


All polarities are referenced to MT1 Whith in -phase signal (using standard AC lines) quadrants I and III are used











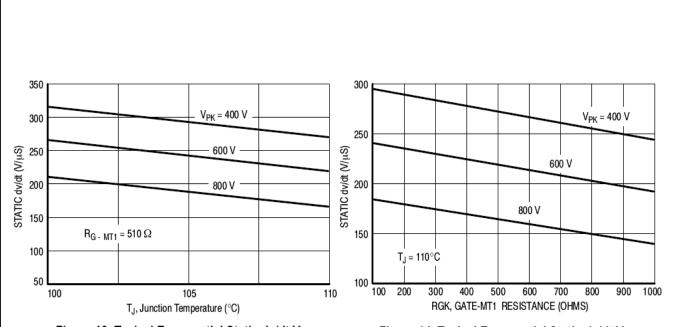


Figure 13. Typical Exponential Static dv/dt Versus Junction Temperature, MT2(-)

Figure 14. Typical Exponential Static dv/dt Versus Gate-MT1 Resistance, MT2(-)

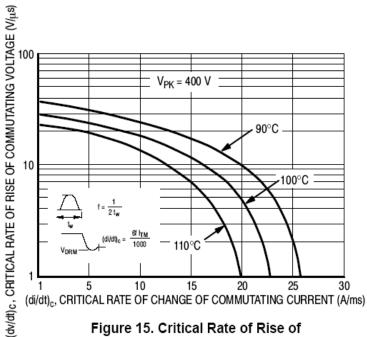


Figure 15. Critical Rate of Rise of **Commutating Voltage**



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